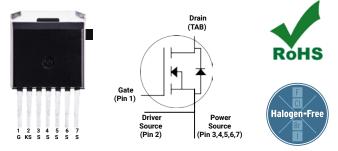


# Silicon Carbide Power MOSFET C3M™ MOSFET Technology N-Channel Enhancement Mode

#### **Features**

- 3rd generation Solicon Carbide (SiC) MOSFET technology
- Low impedance package with driver source pin
- 7mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q<sub>rr</sub>)
- Halogen free, RoHS compliant



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Part Number	Package	Marking
C3M0160120J	TO 263-7	C3M0160120J

## **Typical Applications**

- Renewable energy
- High voltage DC/DC converters
- Switch Mode Power Supplies
- UPS

#### **Benefits**

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

#### **Key Parameters**

Parameter	Symbol	Min.	Тур.	Max	Unit	Conditions	Note
Drain - Source Voltage	V <sub>DS</sub>			1200		T <sub>c</sub> = 25°C	
Maximum Gate - Source Voltage	V <sub>GS(max)</sub>	-8		+19	v	Transient	
Operational Gate-Source Voltage	V <sub>GS op</sub>		-4/15			Static	Note 1
DC Continuous Drain Current	I <sub>D</sub>			17	A	$V_{GS} = 15 \text{ V}, T_{C} = 25 \text{ °C}, T_{J} \le 150 \text{ °C}$	Fig. 19 Note 2
				12		$V_{GS} = 15 \text{ V}, T_{C} = 100 \text{ °C}, T_{J} \le 150 \text{ °C}$	
Pulsed Drain Current	I <sub>DM</sub>			34		$t_{Pmax}$ limited by $T_{jmax}$ $V_{GS} = 15V$ , $T_{C} = 25$ °C	Fig. 22
Power Dissipation	P <sub>D</sub>			90	w	$T_{c} = 25 ^{\circ} \text{C}, T_{J} = 150 ^{\circ} \text{C}$	Fig. 20
Operating Junction and Storage Temperature	$T_{J}, T_{stg}$			-55 to +150	°C		
Solder Temperature	T <sub>L</sub>			260		According to JEDEC J-STD-020	

 $Note~(1): Recommended~turn-on~gate~voltage~is~15V~with~\pm5\%~regulation~tolerance, see~Application~Note~PRD-04814~for~additional~details~tolerance, see~Application~details~tolerance, see~Application~de$ 

Note (2): Verified by design

# **Electrical Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

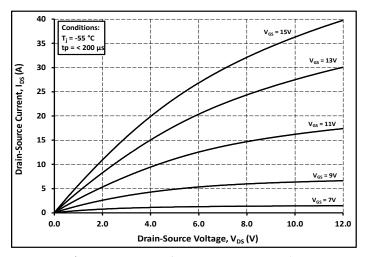
Parameter	Symbol	Min.	Тур.	Max.	Unit	<b>Test Conditions</b>	Note	
Cata Threshold Voltage	V	1.8	2.8	3.6	V	$V_{DS} = V_{GS}$ , $I_{D} = 2.33 \text{ mA}$	Fig. 11	
Gate Threshold Voltage	$V_{GS(th)}$	_	2.2	_	V	$V_{DS} = V_{GS}$ , $I_D = 2.33$ mA, $T_J = 150$ °C	Fig. 11	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	1	100	μΑ	V <sub>DS</sub> = 1200 V, V <sub>GS</sub> = 0 V		
Gate-Source Leakage Current	I <sub>GSS</sub>	_	10	250	nA	$V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$		
Dunin Sauras On State Peristanas	Б	_	160	208	0	$V_{GS} = 15 \text{ V}, I_{D} = 8.5 \text{ A}$	Fig.	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	_	256	_	mΩ	V <sub>GS</sub> = 15 V, I <sub>D</sub> = 8.5 A, T <sub>J</sub> = 150°C	4, 5, 6	
Transconductance	_		5.2		S	$V_{DS} = 20 \text{ V}, I_{DS} = 8.5 \text{ A}$	Fig. 7	
Transconductance	<b>g</b> fs	_	4.9	_		$V_{DS} = 20 \text{ V}, I_{DS} = 8.5 \text{ A}, T_{J} = 150 ^{\circ}\text{C}$		
Input Capacitance	C <sub>iss</sub>	_	632	_			Fig. 17, 18	
Output Capacitance	C <sub>oss</sub>	_	39	_	pF	$V_{GS} = 0 \text{ V}, V_{DS} = 1000 \text{ V}$ f = 1  Mhz		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	3	_		$V_{AC} = 25 \text{ mV}$	11,10	
C <sub>oss</sub> Stored Energy	E <sub>oss</sub>	_	22.5	_		7.0	Fig. 16	
Turn-On Switching Energy (Body Diode FWD)	E <sub>on</sub>	_	64	_	μJ	$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 8.5 \text{ A},$	Fig.	
Turn Off Switching Energy (Body Diode FWD)	E <sub>off</sub>	_	13	_		$R_{G(ext)} = 0 \Omega$ , L= 336 $\mu$ H	26, 29	
Turn-On Delay Time	t <sub>d(on)</sub>	_	11	_		$V_{DD} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$		
Rise Time	t <sub>r</sub>	_	8	_	ne	$I_D = 8.5 \text{ A}, R_{G(ext)} = 0 \Omega,$	Fig. 27, 28, 29	
Turn-Off Delay Time	$t_{d(off)}$	_	14	_	ns	Timing relative to V <sub>DS</sub>		
Fall Time	t <sub>f</sub>	_	. 8	_		Inductive load		
Internal Gate Resistance	R <sub>G(int)</sub>	_	٥	_	Ω	$f = 1 \text{ MHz}, V_{AC} = 25 \text{ mV}$		
Gate to Source Charge	$Q_{\rm gs}$	_	11	_	$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$		Fig. 12	
Gate to Drain Charge	$Q_{\mathrm{gd}}$	_	5	_				
Total Gate Charge	Qg	_	24	_		Per IEC60747-8-4 pg 21		

# **Reverse Diode Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	<b>Test Conditions</b>	Notes	
Diada Famuard Valtara	V	4.4	_	V	$V_{GS} = -4 \text{ V}, I_{SD} = 3 \text{ A}$	Fig.	
Diode Forward Voltage	$V_{SD}$	4.0	_		V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 3 A, T <sub>J</sub> = 150°C	8, 9, 10	
Continuous Diode Forward Current	Is	_	17		$V_{GS} = -4 \text{ V}, T_{J} = 25^{\circ}\text{C}$		
Diode Pulse Current	I <sub>S, pulse</sub>	_	34	А	$V_{GS} = -4 V$ , pulse width $t_P$ limited by $T_{j max}$		
Reverse Recovery Time	t <sub>rr</sub>	5	_	ns		F:- 20	
Reverse Recovery Charge	Qrr	65	_	nC	$V_{GS} = -4 \text{ V}, I_{SD} = 8.5 \text{ A}, V_{R} = 800 \text{ V}$ $di_{z}/dt = 8925 \text{ A}/\mu\text{s}, T_{J} = 25^{\circ}\text{C}$		
Peak Reverse Recovery Current	I <sub>RRM</sub>	19	_	Α	αι <sub>μ</sub> ατ 032377 μ3, 1  23  0		
Reverse Recovery Time	t <sub>rr</sub>	7	_	ns		Fig. 29	
Reverse Recovery Charge	Q <sub>rr</sub>	32	_	nC	$V_{GS} = -4 \text{ V}, I_{SD} = 8.5 \text{ A}, V_{R} = 800 \text{ V}$ $di_{z}/dt = 2020 \text{ A}/\mu\text{s}, T_{J} = 25^{\circ}\text{C}$		
Peak Reverse Recovery Current	I <sub>RRM</sub>	8	_	Α	αι <sub>μ</sub> ατ 2020 / γμο, τη 20 C		

## **Thermal Characteristics**

Parameter	Symbol	Typ.	Unit	Note
Thermal Resistance from Junction to Case	$R_{ heta JC}$	1.38	°C/W	Fig. 21



**Figure 1.** Output Characteristics  $T_J = -55^{\circ}C$ 

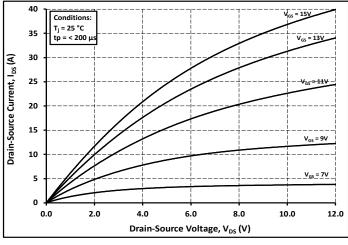


Figure 2. Output Characteristics T<sub>J</sub> = 25°C

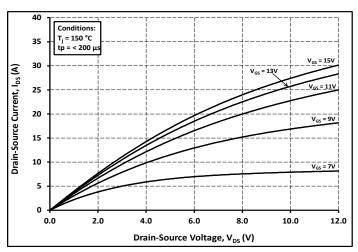


Figure 3. Output Characteristics T<sub>J</sub> = 150°C

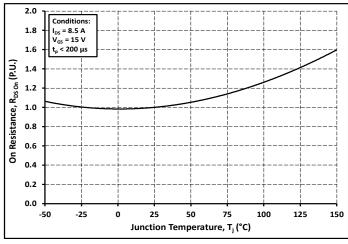
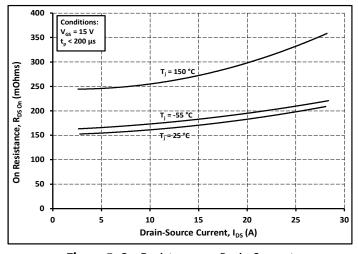
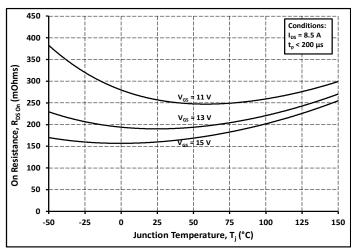


Figure 4. Normalized On-Resistance vs. Temperature

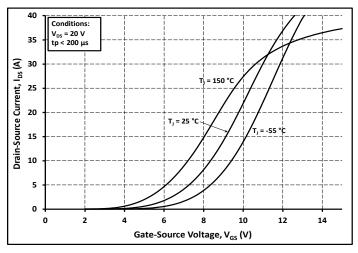


**Figure 5.** On-Resistance vs. Drain Current For Various Temperatures



**Figure 6.** On-Resistance vs. Temperature For Various Gate Voltage

# 4



**Figure 7.** Transfer Characteristic for Various Junction Temperatures

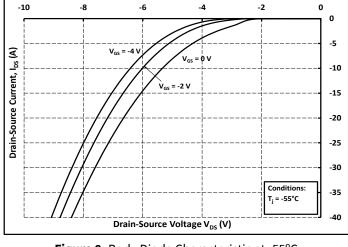


Figure 8. Body Diode Characteristic at -55°C

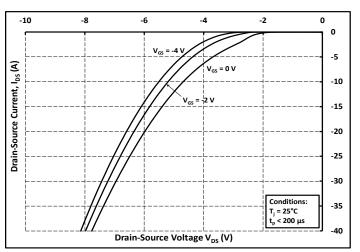


Figure 9. Body Diode Characteristic at 25°C

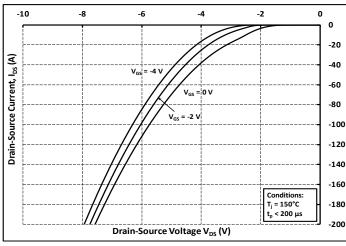


Figure 10. Body Diode Characteristic at 150°C

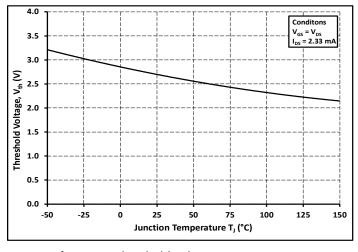


Figure 11. Threshold Voltage vs. Temperature

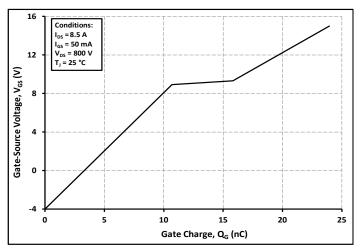


Figure 12. Gate Charge Characteristics

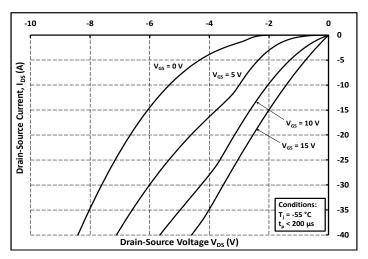


Figure 13. 3rd Quadrant Characteristic at -55°C

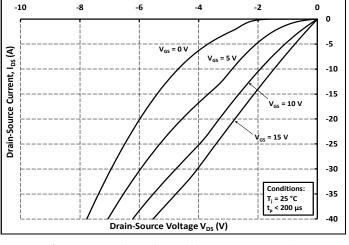


Figure 14. 3rd Quadrant Characteristic at 25°C

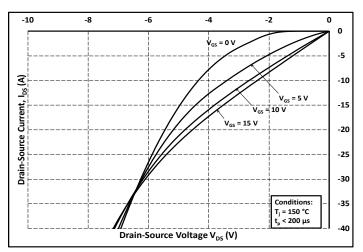


Figure 15. 3rd Quadrant Characteristic at 150°C

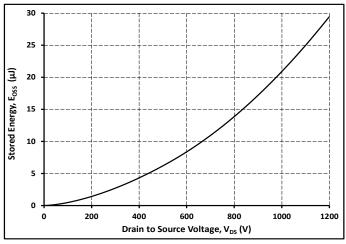
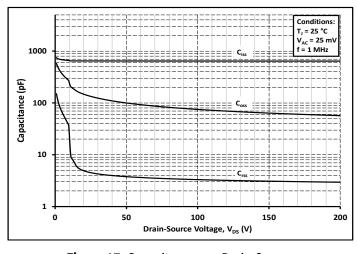
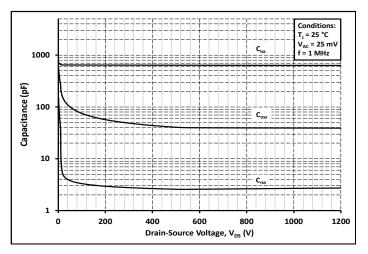


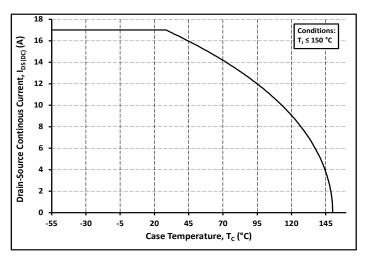
Figure 16. Output Capacitor Stored Energy



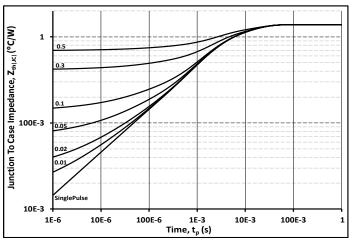
**Figure 17.** Capacitances vs. Drain-Source Voltage (0 - 200 V)



**Figure 18.** Capacitances vs. Drain-Source Voltage (0 - 1200 V)



**Figure 19.** Continuous Drain Current Derating vs. Case Temperature



**Figure 21.** Transient Thermal Impedance (Junction - Case)

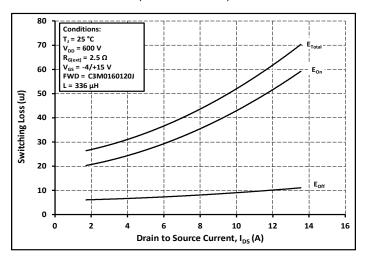
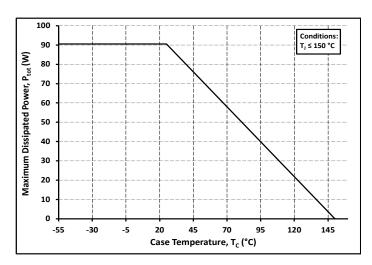


Figure 23. Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 600 \text{ V}$ )



**Figure 20.** Maximum Power Dissipation Derating vs. Case Temperature

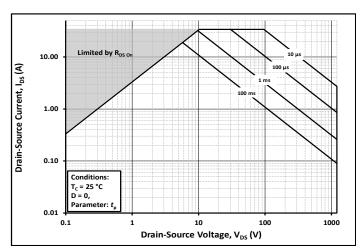
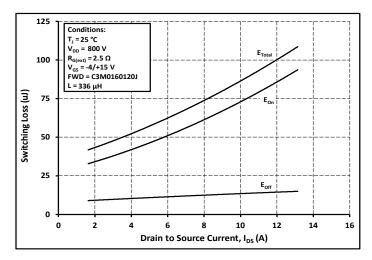


Figure 22. Safe Operating Area



**Figure 24.** Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 800 \text{ V}$ )

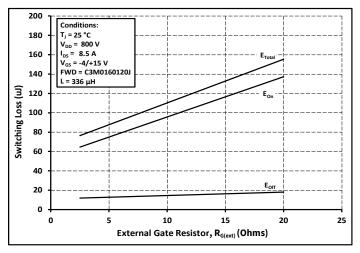


Figure 25. Clamped Inductive Switching Energy vs R<sub>G(ext)</sub>

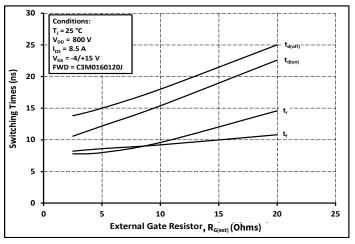


Figure 27. Switching Times vs R<sub>G(ext)</sub>

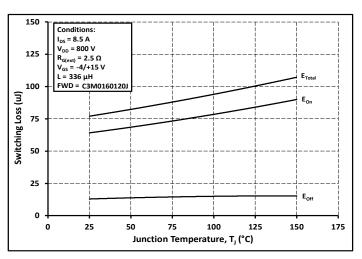


Figure 26. Clamped Inductive Switching Energy vs Temperature

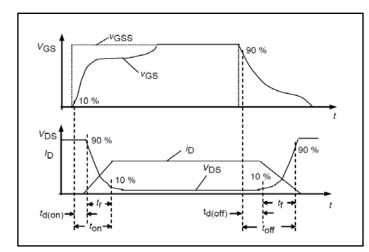


Figure 28. Switching Times Definition

#### **Test Circuit Schematic**

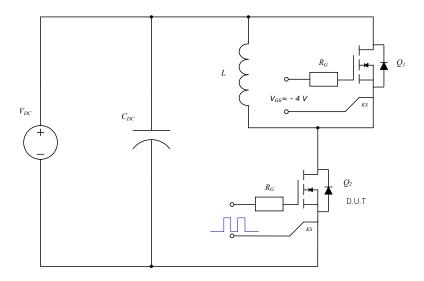


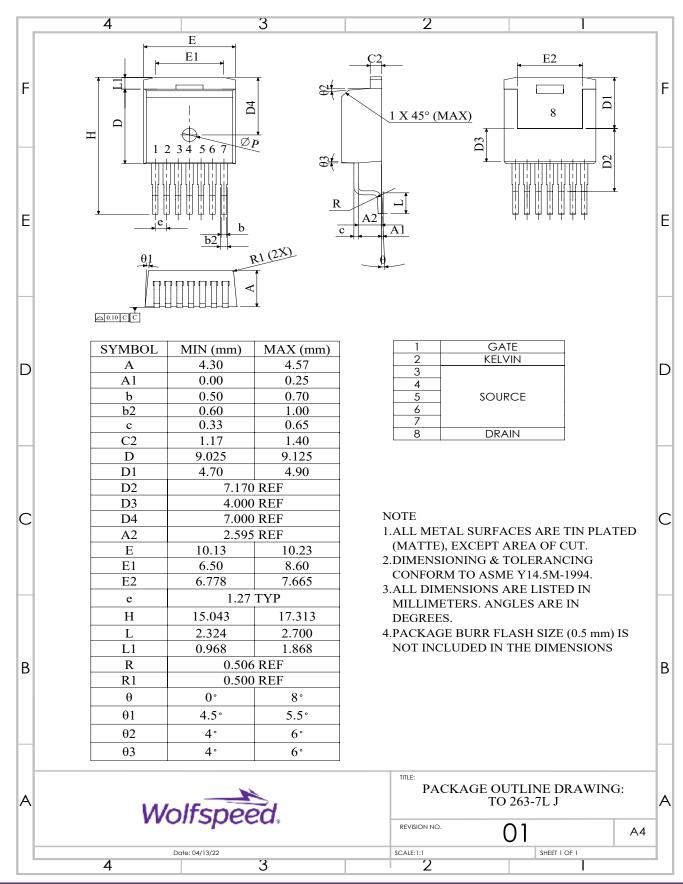
Figure 29. Clamped Inductive Switching Waveform Test Circuit

#### Note:

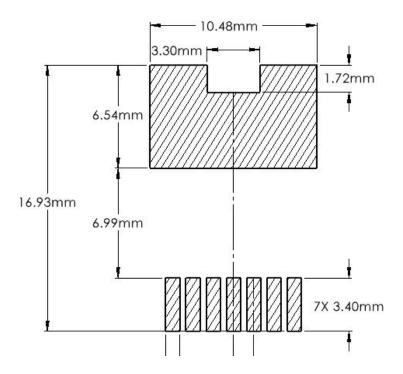
Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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## Package Dimensions - Package 7L D2PAK



# **Recommended Solder Pad Layout**



# **Revision History**

Current Revision	Date of Release	Description of Changes
A	April-2020	N/A
2	December-2023	Updated Wolfspeed branding, package drawing, package image, solder pad layout, added Rev history, Table 1 layout revised
3	December - 2024	Legal Disclaimer Updated

#### **Related Links**

- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

#### Notes & Disclaimer

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